WINSTAR Display

OLED SPECIFICATION

Model No:

## *WEP012864Q*

General Specification

Item	Dimension	Unit
Dot Matrix	128 x 64	─
Module dimension	82.0 × 47.5 × 7 Max.	mm
Active Area	61.41 × 30.69	mm
Pixel Size	0.45 × 0.45	mm
Pixel Pitch	0.48 × 0.48	mm
Display Mode	Passive Matrix	
Display Color	Monochrome	
Drive Duty	1/64 Duty	
OLED IC	SSD1309	
OLED Interface	6800,8080,4-Wire SPI,I2C	
Size	2.7 inch	

Contour Drawing & Block Diagram

Active Area 2.7"

Dots 128*64

Component Area
(Height=3.1 Max)
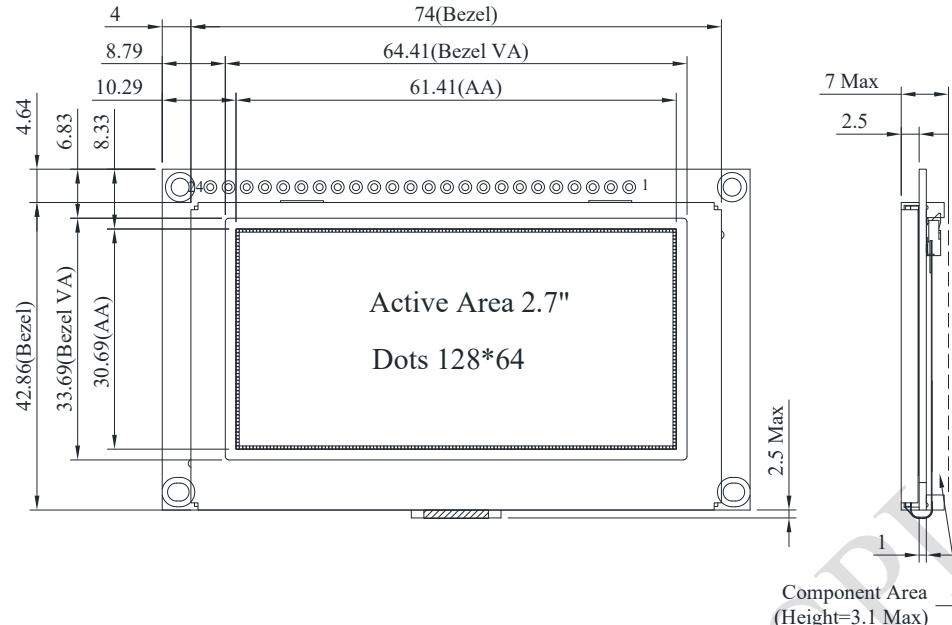
PIN	SYMBOL	PIN	SYMBOL	PIN	SYMBOL
1	VSS	9	DB2	17	CS#
2	VDD	10	DB3	18	NC
3	NC	11	DB4	19	BS2
4	D/C#	12	DB5	20	BS1
5	R/W#(WR#)	13	DB6	21	NC
6	E(/RD#)	14	DB7	22	NC
7	DB0	15	NC	23	NC
8	DB1	16	RES#	24	NC

128*64

C64(COM63) ~ C2(COM32) S128(SEG127) ~ S1(SEG0) C1(COM0) ~ C63(COM31)

SEG & COM Layout

Dots Size
Scale 10/1
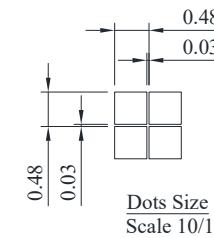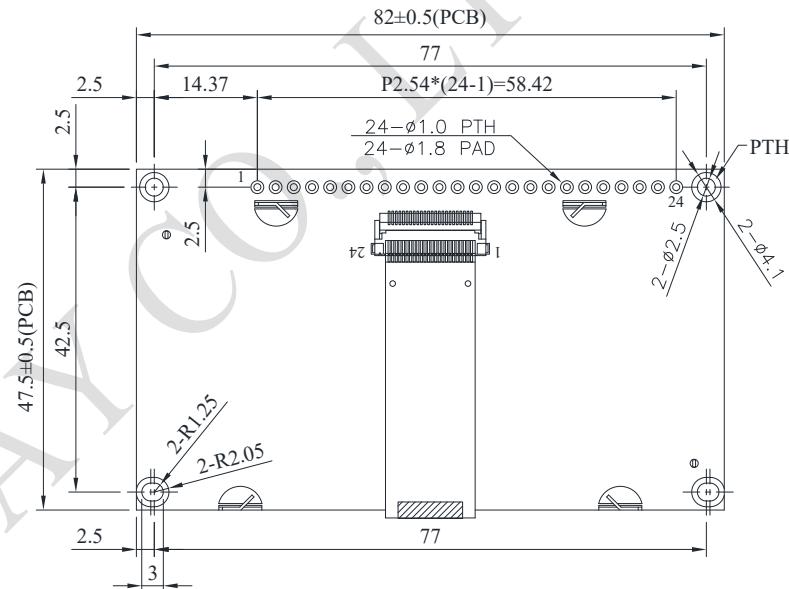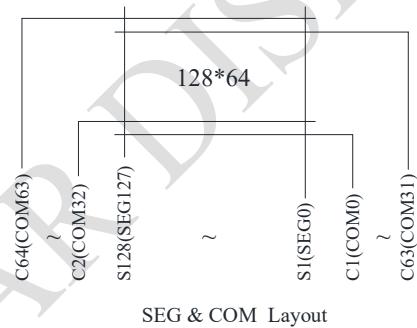
The non-specified tolerance of dimension is ±0.3 mm .

Interface Pin Function

No.	Symbol	Function
1	VSS	Ground.
2	VDD	Power supply pin for core logic operation
3	NC	No connection
4	D/C#	This pin is Data/Command control pin connecting to the MCU. When the pin is pulled HIGH, the data at D[7:0] will be interpreted as data. When the pin is pulled LOW, the data at D[7:0] will be transferred to a command register. In I2C mode, this pin acts as SA0 for slave address selection.
5	R/W# (WR#)	This pin is read / write control input pin connecting to the MCU interface. When 6800 interface mode is selected, this pin will be used as Read/Write (R/W#) selection input. Read mode will be carried out when this pin is pulled HIGH and write mode when LOW. When 8080 interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled LOW and the chip is selected. When serial or I2C interface is selected, this pin must be connected to VSS.
6	E(/RD#)	This pin is MCU interface input. When 6800 interface mode is selected, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled HIGH and the chip is selected. When 8080 interface mode is selected, this pin receives the Read (RD#) signal. Read operation is initiated when this pin is pulled LOW and the chip is selected. When serial or I2C interface is selected, this pin must be connected to VSS.
7-14	D0~D7	These pins are bi-directional data bus connecting to the MCU data bus. Unused pins are recommended to tie LOW. When serial interface mode is selected, D0 will be the serial clock input: SCLK; D1 will be the serial data input: SDIN and D2 should be kept NC. When I2C mode is selected, D2, D1 should be tied together and serve as SDAout, SDAin in application and D0 is the serial clock input, SCL.
15	NC	No connection
16	RES#	This pin is reset signal input. When the pin is pulled LOW, initialization of the chip is executed. Keep this pin pull HIGH during normal operation.
17	CS#	This pin is the chip select input connecting to the MCU. The chip is enabled for MCU communication only when CS# is pulled LOW (active LOW).
18	NC	No connection

19	BS2	MCU bus interface selection pins. Select appropriate logic setting as described in the following table. BS2 and BS1 are pin select
20	BS1	<table><tr><td></td><td>BS1</td><td>BS2</td></tr><tr><td>I 2 C</td><td>1</td><td>0</td></tr><tr><td>4-wire Serial</td><td>0</td><td>0</td></tr><tr><td>8-bit 68XX Parallel</td><td>0</td><td>1</td></tr><tr><td>8-bit 80XX Parallel</td><td>1</td><td>1</td></tr></table> Note (1) 0 is connected to VSS (2) 1 is connected to VDD
21	NC	No connection
22	NC	No connection
23	NC	No connection
24	NC	No connection

Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage for Logic	VDD	-0.3	4.0	V
Operating Temperature	TOP	-40	+80	°C
Storage Temperature	TSTG	-40	+85	°C

Electrical Characteristics

DC Electrical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage for Logic	VDD	—	2.8	3.0	3.3	V
High Level Input	VIH	—	0.8×VDD	—	—	V
Low Level Input	VIL	—	—	—	0.2×VDD	V
High Level Output	VOH	—	0.9×VDD	—	—	V
Low Level Output	VOL	—	—	—	0.1×VDD	V
50% Check Board operating Current	VDD =3V	—	100	200	mA